74ALVT162821

20-bit bus interface D-type flip-flop; positive-edge trigger with 30 Ω termination resistors; 3-state

Rev. 6 — 25 June 2024

Product data sheet

1. General description

The 74ALVT162821 is a 20-bit positive-edge triggered D-type flip-flop with 30 Ω termination resistors and 3-state outputs

The device can be used as two 10-bit flip-flops or one 20-bit flip-flop. The device features two clocks (1CP and 2CP) and two output enables (1 \overline{OE} and 2 \overline{OE}), each controlling 10-bits. The flip-flops will store the state of their individual D-inputs that meet the set-up and hold time requirements on the LOW-to-HIGH clock (nCP) transition. A HIGH on n \overline{OE} causes the outputs to assume a high-impedance OFF-state. Operation of the n \overline{OE} input does not affect the state of the flip-flops. Bus hold data inputs eliminate the need for external pull-up resistors to define unused inputs

2. Features and benefits

- Wide supply voltage range from 2.3 V to 3.6 V
- Overvoltage tolerant inputs to 5.5 V
- BiCMOS high speed and output drive
- Outputs include series resistance of 30 Ω making external termination resistors unnecessary
- No bus current loading when output is tied to 5 V bus
- Direct interface with TTL levels
- I_{OFF} circuitry provides partial Power-down mode operation
- 20-bit positive-edge triggered register
- 5 V I/O compatible
- Multiple V_{CC} and GND pins minimize switching noise
- Bus hold on data inputs
- Live insertion and extraction permitted
- Power-up reset
- Power-up 3-state
- Output capability: +12 mA and -12 mA
- Latch-up protection:
 - JESD17: exceeds 500 mA
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to 85 °C

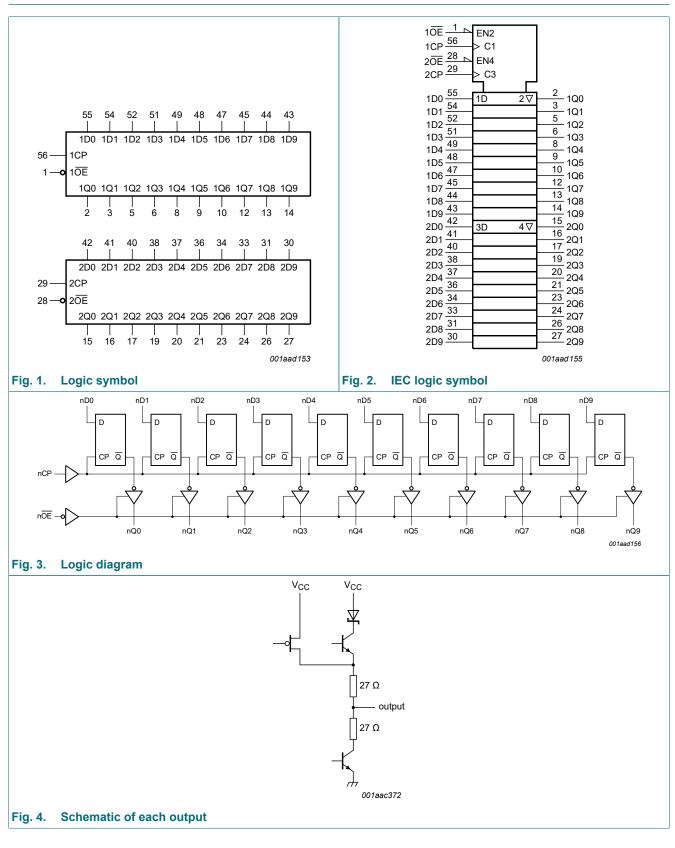
3. Ordering information

Table 1.	Ordering	information	

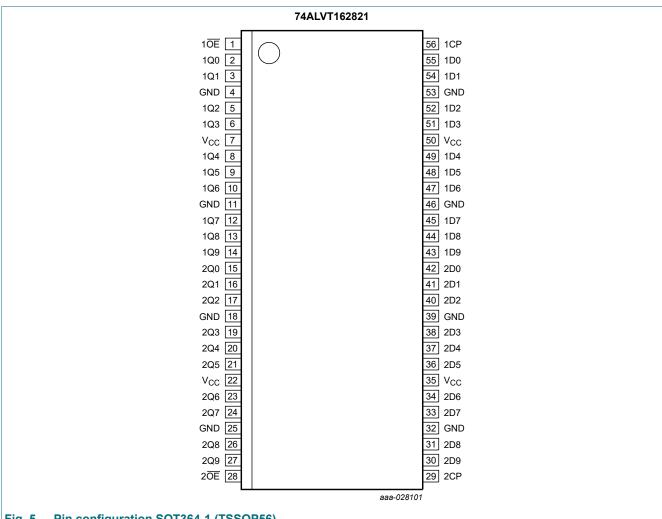
Type number	Package	e								
	Temperature range									
74ALVT162821DGG	-40 °C to +85 °C	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	<u>SOT364-1</u>						

ne<mark>x</mark>peria

4. Functional diagram



5. Pinning information



5.1. Pinning

Fig. 5.Pin configuration SOT364-1 (TSSOP56)

5.2. Pin description

Table 2. Pin description								
Symbol	Pin	Description						
1D0, 1D1, 1D2, 1D3, 1D4, 1D5, 1D6, 1D7, 1D8, 1D9	55, 54, 52, 51, 49, 48, 47, 45, 44, 43	data inputs						
1Q0, 1Q1, 1Q2, 1Q3, 1Q4, 1Q5, 1Q6, 1Q7, 1Q8, 1Q9	2, 3, 5, 6, 8, 9, 10, 12, 13, 14	data outputs						
2D0, 2D1, 2D2, 2D3, 2D4, 2D5, 2D6, 2D7, 2D8, 2D9	42, 41, 40, 38, 37, 36, 34, 33, 31, 30	data inputs						
2Q0, 2Q1, 2Q2, 2Q3, 2Q4, 2Q5, 2Q6, 2Q7, 2Q8, 2Q9	15, 16, 17, 19, 20, 21, 23, 24, 26, 27	data outputs						
10E, 20E	1, 28	output enable inputs (active LOW)						
1CP, 2CP	56, 29	clock pulse inputs (active rising edge)						
GND	4, 11, 18, 25, 32, 39, 46, 53	ground (0 V)						
V _{CC}	7, 22, 35, 50	supply voltage						

Table 2. Pin description

6. Functional description

Table 3. Function table

H = HIGH voltage level; *h* = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;

L = LOW voltage level; I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;

NC = no change; X = don't care;

 $Z = high-impedance OFF-state; \uparrow = LOW-to-HIGH clock transition.$

Operating mode	Input		Internal register	Output	
	nOE	nCP nDn			nQn
Load and read register	L	1	I	L	L
	L	1	h	Н	Н
Hold	L	NC	Х	NC	NC
Disable outputs	Н	NC	Х	NC	Z
	Н	1	nDn	nDn	Z

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+4.6	V
VI	input voltage		[1]	-1.2	+7.0	V
Vo	output voltage	output in OFF-state or HIGH-state	[1]	-0.5	+7.0	V
I _{IK}	input clamping current	V _I < 0 V		-	-50	mA
I _{OK}	output clamping current	V ₀ < 0 V		-	-50	mA
I _O	output current	output in LOW-state		-	128	mA
		output in HIGH-state		-	-64	mA
T _{stg}	storage temperature			-65	+150	°C
Tj	junction temperature		[2]	-	150	°C

[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	V _{CC} = 2.5	V ± 0.2 V	V _{CC} = 3.3	Unit	
			Min	Max	Min	Max	
V _{CC}	supply voltage		2.3	2.7	3.0	3.6	V
VI	input voltage		0	5.5	0	5.5	V
I _{OH}	HIGH-level output current		-	-8	-	-12	mA
I _{OL}	LOW-level output current	none	-	12	-	12	mA
Δt/ΔV	input transition rise and fall rate	outputs enabled	-	10	-	10	ns/V
T _{amb}	ambient temperature	free-air	-40	+85	-40	+85	°C

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; T_{amb} = -40 °C to +85 °C; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
V _{CC} = 2.5	5 V ± 0.2 V					
V _{IK}	input clamping voltage	V _{CC} = 2.3 V; I _{IK} = -18 mA	-	-0.85	-1.2	V
V _{IH}	HIGH-level input voltage		1.7	-	-	V
V _{IL}	LOW-level input voltage		-	-	0.7	V
V _{OH}	HIGH-level output voltage	V_{CC} = 2.3 V to 3.6 V; I _O = -100 μ A	V _{CC} - 0.2	V _{CC}	-	V
		V _{CC} = 2.3 V; I _O = -8 mA	1.8	2.1	-	V
V _{OL}	LOW-level output voltage	V _{CC} = 2.3 V; I _O = 100 μA	-	0.07	0.2	V
		V _{CC} = 2.3 V; I _O = 24 mA	-	0.3	0.5	V
		V _{CC} = 2.3 V; I _O = 8 mA	-	-	0.4	V
V _{OL(pu)}	power-up LOW-level output voltage	$V_{CC} = 2.7 \text{ V}; I_0 = 1 \text{ mA}; V_1 = V_{CC} \text{ or GND}$ [2]	-	-	0.55	V

Symbol	Parameter	Conditions		Min	Typ <mark>[1]</mark>	Max	Unit
I _I	input leakage current	all input pins					
		V _{CC} = 0 V or 2.7 V; V _I = 5.5 V		-	0.1	10	μA
IOFF P4 IOFF P4 IBHL b1 IBHH b1 IEX ex IO(pu/pd) P4 IOZ O IOZ O IOC SI IOC SI CI in CI in CO O VIK in VIK In VIH H VOH H		control pins					
		V_{CC} = 2.7 V; V_{I} = V_{CC} or GND		-	0.1	±1	μA
		data pins;	[3]				
		$V_{CC} = 2.7 \text{ V}; \text{ V}_{I} = V_{CC}$		-	0.1	1	μA
		V _{CC} = 2.7 V; V _I = 0 V		-	0.1	-5	μA
I _{OFF}	power-off leakage current	$V_{CC} = 0 V; V_{I} \text{ or } V_{O} = 0 V \text{ to } 4.5 V$		-	0.1	±100	μA
I _{BHL}	bus hold LOW current	data inputs; V_{CC} = 2.3 V; V_{I} = 0.7 V		-	90	-	μA
I _{BHH}	bus hold HIGH current	data inputs; V _{CC} = 2.3 V; V _I = 1.7 V		-	-10	-	μA
I _{EX}	external current	$_{1}$ = GND or V _{CC} ; nOE = don't care		-	10	125	μA
I _{O(pu/pd)}	power-up/power-down output current	$V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V to } V_{CC};$ V ₁ = GND or V _{CC} ; nOE = don't care	[4]	-	1	±100	μA
I _{OZ}	OFF-state output current	V_{CC} = 2.7 V; V_{I} = V_{IL} or V_{IH}					
		output HIGH-state; V _O = 2.3 V		-	0.5	5	μA
		output LOW-state; V _O = 0.5 V		-	0.5	-5	μA
l _{CC} s	supply current	V_{CC} = 2.7 V; V_I = GND or V_{CC} ; I_O = 0 A					
		outputs HIGH-state		-	0.04	0.1	mA
		outputs LOW-state		-	2.3	4.5	mA
		outputs disabled	[5]		0.04	0.1	mA
ΔI _{CC}	additional supply current	per input pin; V_{CC} = 2.3 V to 2.7 V; one input at V_{CC} - 0.6 V; other inputs at V_{CC} or GND	[6]	-	0.04	0.4	mA
CI	input capacitance	V _I = 0 V or V _{CC}		-	3	-	pF
Co	output capacitance	$V_{O} = 0 V \text{ or } V_{CC}$		-	9	-	pF
V _{CC} = 3.3	3 V ± 0.3 V						
V _{IK}	input clamping voltage	V _{CC} = 3.0 V; I _{IK} = -18 mA		-	-0.85	-1.2	V
VIH	HIGH-level input voltage			2.0	-	-	V
V _{IL}	LOW-level input voltage			-	-	0.8	V
V _{OH}	HIGH-level output voltage	V_{CC} = 3.0 V to 3.6 V; I _O = -100 µA	V _C	_c - 0.2	V _{CC}	-	V
		V _{CC} = 3.0 V; I _O = -32 mA		2.0	2.3	-	V
V _{OL}	LOW-level output voltage	V _{CC} = 3.0 V					
		I _O = 100 μA		-	0.07	0.2	V
		I _O = 16 mA		-	0.25	0.4	V
		I _O = 32 mA		-	0.3	0.5	V
		I _O = 64 mA		-	0.4	0.55	V
V _{OL(pu)}	power-up LOW-level output voltage	V_{CC} = 3.6 V; I _O = 1 mA; V _I = V _{CC} or GND	[2]	-	-	0.55	V

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Symbol	Parameter	Conditions		Min	Typ[1]	Мах	Unit
I _{OFF} I _{BHL} I _{BHL} I _{BHLO} I _{BHHO} I _{EX} I _{O(pu/pd)} I _{OZ} I _{CC}	input leakage current	all input pins;					
		V _{CC} = 0 V or 3.6 V; V _I = 5.5V		-	0.1	10	μA
OFF PO BHL DU BHL DU BHHO DU BHHO DU BHHO DU CC SU		control pins					
		V_{CC} = 3.6 V; V_{I} = V_{CC} or GND		-	0.1	±1	μA
		data pins;	[3]				
		$V_{CC} = 3.6 \text{ V}; \text{ V}_{I} = V_{CC}$		-	0.5	1	μA
		V _{CC} = 3.6 V; V _I = 0 V		-	0.1	-5	μA
I _{OFF}	power-off leakage current	V_{CC} = 0 V; V ₁ or V ₀ = 0 V to 4.5 V		-	0.1	±100	μA
I _{BHL}	bus hold LOW current	data inputs; V_{CC} = 3 V; V_{I} = 0.8 V		75	130	-	μA
I _{BHH}	bus hold HIGH current	data inputs; V_{CC} = 3 V; V_{I} = 2.0 V		-75	-140	-	μA
I _{BHLO}	bus hold LOW overdrive current	data inputs; V_{CC} = 3.6 V; V_{I} = 0 V to 3.6 V	[7]	500	-	-	μA
I _{BHHO}	bus hold HIGH overdrive current	data inputs; V_{CC} = 3.6 V; V_{I} = 0 V to 3.6 V	[7]	-500	-	-	μA
I _{EX}	external current	output in HIGH-state when $V_0 > V_{CC}$; $V_0 = 5.5 \text{ V}$; $V_{CC} = 3.0 \text{ V}$		-	10	125	μA
I _{O(pu/pd)}	power-up/power-down output current	$V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V to } V_{CC};$ V _I = GND or V _{CC} ; nOE = don't care	[8]	-	1	±100	μA
l _{oz}	OFF-state output current	V_{CC} = 3.6 V; V_{I} = V_{IL} or V_{IH}					
		output HIGH-state; V _O = 3.0 V		-	0.5	5	μA
		output LOW-state; V _O = 0.5 V		-	0.5	-5	μA
I _{CC}	supply current	V_{CC} = 3.6 V; V _I = GND or V_{CC} ; I _O = 0 A					
		outputs HIGH-state		-	0.07	0.1	mA
		outputs LOW-state		-	5.1	7	mA
		outputs disabled	[5]	-	0.07	0.1	mA
ΔI _{CC}	additional supply current	per input pin; V_{CC} = 3 V to 3.6 V; one input at V_{CC} - 0.6 V; other inputs at V_{CC} or GND	[6]	-	0.04	0.4	mA
CI	input capacitance	V _I = 0 V or V _{CC}		-	3	-	pF
Co	output capacitance	$V_{O} = 0 V \text{ or } V_{CC}$		-	9	-	pF

[1] All typical values for V_{CC} = 2.5 V \pm 0.2 V are measured at V_{CC} = 2.5 V and T_{amb} = 25 °C.

All typical values for V_{CC} = 3.3 V \pm 0.3 V are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

[2] For valid test results, data must not be loaded into the flip-flops (or latches) after applying power.

[3] Unused pins at V_{CC} or GND.

[4] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms.

From V_{CC} = 1.2 V to (2.5 ± 0.2) V a transition time of 100 μ s is permitted. This parameter is valid for T_{amb} = 25 °C only.

[5] I_{CC} with outputs disabled is measured with outputs pulled to V_{CC} or GND.

[6] This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND.

[7] This is the bus hold overdrive current required to force the input to the opposite logic state.

[8] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms.

From V_{CC} = 1,2 V to (3.3 ± 0.3) V a transition time of 100 µs is permitted. This parameter is valid for T_{amb} = 25 °C only.

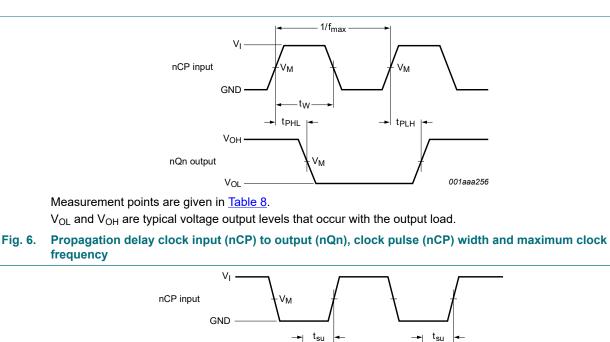
10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); T_{amb} = -40 °C to +85 °C; for test circuit see Fig. 9.

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
V _{CC} = 2.	5 V ± 0.2 V	1				
t _{PLH}	LOW to HIGH propagation delay	nCP to nQn; see <u>Fig. 6</u>	1.0	4.4	7.0	ns
t _{PHL}	HIGH to LOW propagation delay	nCP to nQn; see <u>Fig. 6</u>	1.0	3.8	6.4	ns
t _{PZH}	OFF-state to HIGH propagation delay	nOE to nQn; see <u>Fig. 8</u>	1.5	4.6	7.5	ns
t _{PZL}	OFF-state to LOW propagation delay	nOE to nQn; see <u>Fig. 8</u>	1.0	2.8	4.6	ns
t _{PHZ}	HIGH to OFF-state propagation delay	nOE to nQn; see <u>Fig. 8</u>	1.5	3.5	5.5	ns
t _{PLZ}	LOW to OFF-state propagation delay	nOE to nQn; see <u>Fig. 8</u>	1.0	3.7	5.7	ns
t _{su}	set-up time	nDn to nCP HIGH; see <u>Fig. 7</u>	1.5	0.1	-	ns
		nDn to nCP LOW; see <u>Fig. 7</u>	2.0	0.5	-	ns
t _h	hold time	nDn to nCP HIGH; see <u>Fig. 7</u>	0.3	-0.5	-	ns
		nDn to nCP LOW; see <u>Fig. 7</u>	0.5	-0.1		ns
t _W	pulse width	nCP HIGH or LOW; see Fig. 6	1.5	-	-	ns
f _{max}	maximum frequency	nCP; see <u>Fig. 6</u>	150	-	-	MHz
V _{CC} = 3.3	3 V ± 0.3 V					
t _{PLH}	LOW to HIGH propagation delay	nCP to nQn; see <u>Fig. 6</u>	1.0	3.2	5.0	ns
t _{PHL}	HIGH to LOW propagation delay	nCP to nQn; see <u>Fig. 6</u>	1.0	3.2	4.7	ns
t _{PZH}	OFF-state to HIGH propagation delay	nOE to nQn; see <u>Fig. 8</u>	1.0	3.4	5.6	ns
t _{PZL}	OFF-state to LOW propagation delay	nOE to nQn; see <u>Fig. 8</u>	0.5	2.3	3.7	ns
t _{PHZ}	HIGH to OFF-state propagation delay	nOE to nQn; see <u>Fig. 8</u>	1.5	3.7	5.4	ns
t _{PLZ}	LOW to OFF-state propagation delay	nOE to nQn; see <u>Fig. 8</u>	1.5	3.0	4.3	ns
t _{su}	set-up time	nDn to nCP HIGH or LOW; see Fig. 7	1.5	0.1	-	ns
t _h	hold time HIGH	nDn to nCP HIGH or LOW; see Fig. 7	0.5	0.1	-	ns
t _W	pulse width	nCP HIGH or LOW; see Fig. 6	1.5	-	-	ns
f _{max}	maximum frequency	nCP; see <u>Fig. 6</u>	150	-	-	MHz

[1] All typical values for V_{CC} = 2.5 V ± 0.2 V are measured at V_{CC} = 2.5 V and T_{amb} = 25 °C. All typical values for V_{CC} = 3.3 V ± 0.3 V are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.



10.1. Waveforms and test circuit

Measurement points are given in <u>Table 8</u>.

nDn input

nQn output

 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

VI

GND

VOH

VOL

The shaded areas indicate when the input is permitted to change for predictable output performance.

th

Vм

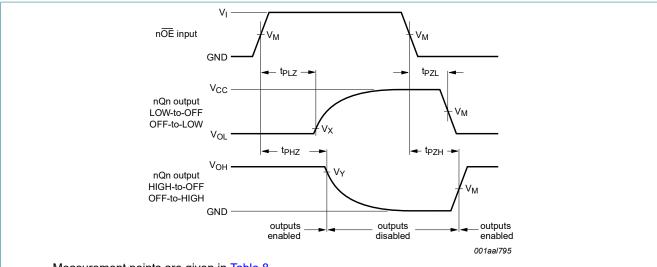
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Vм

Fig. 7. Set-up times and hold times from input (nDn) to clock (nCP)

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Measurement points are given in <u>Table 8</u>.

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 8. OFF-state to HIGH and LOW propagation delays and LOW and HIGH to OFF-state propagation delays

Table 8. Measurement points

V _{cc}	Input		Output			
	VI	V _M	V _M V _X V		V _Y	
V _{CC} ≤ 2.7 V	V _{CC}	0.5 x V _{CC}	0.5 x V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V	
V _{CC} ≥ 3.0 V	3.0 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V	

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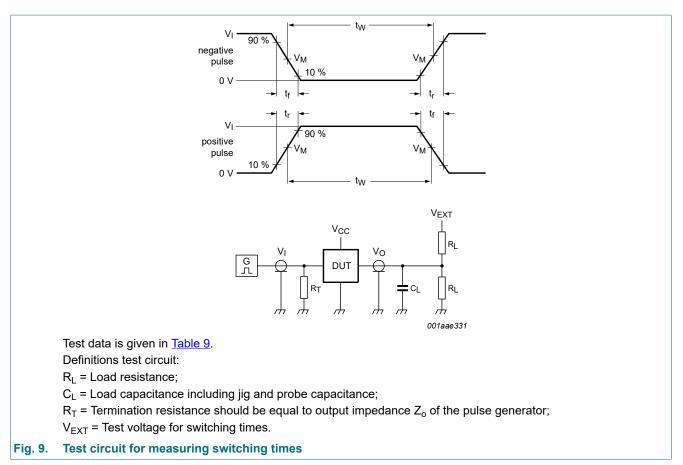


Table 9. Test data

Input			Load		V _{EXT}			
VI	f _i	tw	t _r , t _f	CL	RL	t _{PHZ} , t _{PZH}	t _{PLZ} , t _{PZL}	t _{PLH} , t _{PHL}
3.0 V or V_{CC} whichever is less	≤ 10 MHz	500 ns	≤ 2.5 ns	50 pF	500 Ω	GND	6 V or V _{CC} x 2	open

11. Package outline

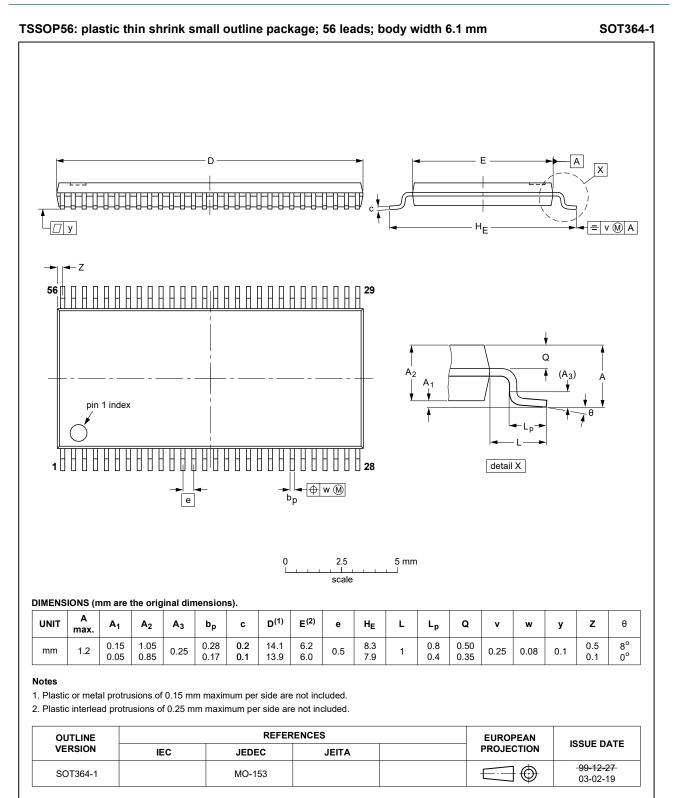


Fig. 10. Package outline SOT364-1 (TSSOP56)

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12. Abbreviations

Table 10. Abbreviations				
Acronym	Description			
ANSI	American National Standards Institute			
BiCMOS	Bipolar Complementary Metal Oxide Semiconductor			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
ESDA	ElectroStatic Discharge Association			
HBM	Human Body Model			
JEDEC	Joint Electron Device Engineering Council			

13. Revision history

Table 11. Revision histor	ſy					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
74ALVT162821 v.6	20240625	Product data sheet	-	74ALVT162821 v.5		
Modifications:	• <u>Section 2</u> : E	• <u>Section 2</u> : ESD specification updated according to the latest JEDEC standard.				
74ALVT162821 v.5	20201019	Product data sheet	-	74ALVT162821 v.4		
Modifications:	 Type number 74ALVT162821DGG (SOT371-1 / SSOP56) removed. Section 1 and Section 2 updated. <u>Table 4</u>: Derating values for P_{tot} total power dissipation updated. 					
74ALVT162821 v.4	20180124	Product data sheet	-	74ALVT162821 v.3		
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. 					
74ALVT162821 v.3	19981002	Product data sheet	-	74ALVT162821 v.2		
74ALVT162821 v.2	19980213	Product specification	-	74ALVT162821 v.1		
74ALVT162821 v.1	19971117	Product specification	-	-		

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

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